Advanced Monolithic Systems

AMS2501

1A VERY LOW DROPOUT VOLTAGE REGULATOR

RoHS compliant

FEATURES

- Adjustable or Fixed Output
  1.5V, 1.8V, 2.5V, 2.85V, 3.0V, 3.3V, 3.5V and 5.0V
- Output Current of 1A
- Low Dropout, typ. 200mV at 500mA Output Current
- Fast Transient Response
- Remote Sense

APPLICATIONS

- High Efficiency Current Regulators
- Post Regulators for Switching Supplies
- Audio/Video/Modem Card Supply
- Adjustable Power Supply
- Notebook/Personal Computer Supplies

GENERAL DESCRIPTION

The AMS2501 series are adjustable and fixed low dropout voltage regulators are designed to provide 1A output current. The dropout voltage of the device is 100mV at light loads and rising to 200mV at 500mA output current. A second input voltage of 1.2V or greater than the output is required to achieve this dropout. The AMS2501 can also be used as a single supply device by connecting pin1 and pin 8 together. In this case the dropout voltage will be typically 1.2V.
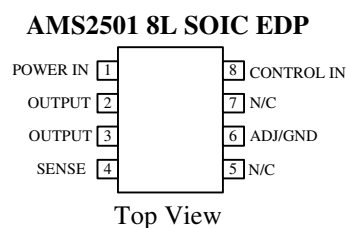
New features have been added to the AMS2501: a remote Sense pin is brought out virtually eliminating output voltage variations due to load changes. The typical load regulation, measured at the Sense pin, for a load current step of 100mA to 1A is less than 1mV. The AMS2501 series has fast transient response and are ideal for generating supplies of 1.25V to 3V where both 5V and 3.3V supplies are available.

The AMS2501 devices are offered in 8 lead EDP package.

ORDERING INFORMATION:

OPERATING JUNCTION	TEMPERATURE RANGE
AMS2501CS	0 to 125° C
AMS2501CS-1.5	0 to 125° C
AMS2501CS-1.8	0 to 125° C
AMS2501CS-2.5	0 to 125° C
AMS2501CS-2.85	0 to 125° C
AMS2501CS-3.0	0 to 125° C
AMS2501CS-3.3	0 to 125° C
AMS2501CS-3.5	0 to 125° C
AMS2501CS-5.0	0 to 125° C

PIN CONNECTIONS

AMS2501 8L SOIC EDP

POWER IN	1		8	CONTROL IN
OUTPUT	2		7	N/C
OUTPUT	3		6	ADJ/GND
SENSE	4		5	N/C

Top View

ABSOLUTE MAXIMUM RATINGS (Note 1)

V_{POWER} Input Voltage	7V	Soldering information	
$V_{CONTROL}$ Input Voltage	13V	Lead Temperature (25 sec)	265°C
Operating Junction Temperature		Thermal Resistance	
Control Section	0°C to 125°C	SO-8 package	φ_{JA}= 60°C/W
Power Transistor	0°C to 150°C		
Storage temperature	- 65°C to +150°C		

ELECTRICAL CHARACTERISTICS

Electrical Characteristics at I_{LOAD} = 0 mA, and T_J = +25°C unless otherwise specified.

Parameter	Device	Conditions	Min	Typ	Max	Units
Reference Voltage	AMS2501	$V_{CONTROL}$ = 2.75V, V_{POWER} =2V, I_{LOAD} = 10mA	1.238	1.250	1.262	V
		$V_{CONTROL}$ = 2.7V to 12V, V_{POWER} =3.3V to 5.5V, I_{LOAD} = 10mA to 1A	**1.232**	**1.250**	**1.268**	V
Output Voltage	AMS2501-1.5	$V_{CONTROL}$ = 4V, V_{POWER} =2.V, I_{LOAD} = 0mA	1.491	1.500	1.509	V
		$V_{CONTROL}$ = 3V, V_{POWER} =2.3V, I_{LOAD} = 0mA to 1A	**1.485**	**1.500**	**1.515**	V
	AMS2501-1.8	$V_{CONTROL}$ = 4V, V_{POWER} =2.V, I_{LOAD} = 0mA	1.782	1.800	1.818	V
		$V_{CONTROL}$ = 3V, V_{POWER} =2.3V, I_{LOAD} = 0mA to 1A	**1.773**	**1.800**	**1.827**	V
	AMS2501-2.5	$V_{CONTROL}$ = 5V, V_{POWER} =3.3V, I_{LOAD} = 0mA	2.485	2.500	2.515	V
		$V_{CONTROL}$ = 4V, V_{POWER} =3.3V, I_{LOAD} = 0mA to 1A	**2.475**	**2.500**	**2.525**	V
	AMS2501-2.85	$V_{CONTROL}$ = 5.35V, V_{POWER} =3.35V, I_{LOAD} = 0mA	2.821	2.850	2.879	V
		$V_{CONTROL}$ = 4.4V, V_{POWER} =3.7V, I_{LOAD} = 0mA to 1A	**2.833**	**2.850**	**2.867**	V
	AMS2501-3.0	$V_{CONTROL}$ = 5.5V, V_{POWER} =3.5V, I_{LOAD} = 0mA	2.982	3.000	3.018	V
		$V_{CONTROL}$ = 4.5V, V_{POWER} =3.8V, I_{LOAD} = 0mA to 1A	**2.970**	**3.000**	**3.030**	V
	AMS2501-3.3	$V_{CONTROL}$ = 5.8V, V_{POWER} =3.8V, I_{LOAD} = 0mA	3.280	3.300	3.320	V
		$V_{CONTROL}$ = 4.8V, V_{POWER} =4.1V, I_{LOAD} = 0mA to 1A	**3.235**	**3.300**	**3.333**	V
	AMS2501-3.5	$V_{CONTROL}$ = 6V, V_{POWER} =4V, I_{LOAD} = 0mA	3.479	3.500	3.521	V
		$V_{CONTROL}$ = 5V, V_{POWER} =4.3V, I_{LOAD} = 0mA to 1A	**3.430**	**3.500**	**3.535**	V
	AMS2501-5.0	$V_{CONTROL}$ = 7.5V, V_{POWER} =5.5V, I_{LOAD} = 0mA	4.930	5.000	5.030	V
		$V_{CONTROL}$ = 6.5V, V_{POWER} =5.8V, I_{LOAD} = 0mA to 1A	**4.950**	**5.000**	**5.050**	V
Line Regulation	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	I_{LOAD} = 10 mA , 1.5V≤ ($V_{CONTROL}$ - V_{OUT}) ≤ 12V 0.8V≤ (V_{POWER} - V_{OUT}) ≤ 5.5V		**1**	**3**	mV
Load Regulation	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	$V_{CONTROL}$ = V_{OUT} + 2.5V, V_{POWER} =V_{OUT} + 0.8V, I_{LOAD} = 10mA to 1A		**1**	**5**	mV
Minimum Load Current	AMS2501	$V_{CONTROL}$ = 5V, V_{POWER} =3.3V, V_{ADJ} = 0V (Note 3)		**5**	**10**	mA
Control Pin Current (Note 4)	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	$V_{CONTROL}$ = V_{OUT} + 2.5V, V_{POWER} =V_{OUT} + 0.8V, I_{LOAD} = 10mA		**10**	**16**	mA
Ground Pin Current (Note 4)	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	$V_{CONTROL}$ = V_{OUT} + 2.5V, V_{POWER} =V_{OUT} + 0.8V, I_{LOAD} = 10mA		**6**	**10**	mA
Adjust Pin Current	AMS2501	$V_{CONTROL}$ = 2.75V, V_{POWER} = 2.05V, I_{LOAD} = 10mA		**40**	**120**	μA
Current Limit	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	V_{POWER} =V_{OUT} + 0.8V	**1.0**	**1.2**	**1.5**	A
Ripple Rejection	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	$V_{CONTROL}$ = V_{POWER} = V_{OUT} + 2.5V, V_{RIPPLE} = 1V_{P-P} I_{LOAD} = 1A	60	80		dB

AMS2501

ELECTRICAL CHARACTERISTICS

Electrical Characteristics at I_{OUT} = 0 mA, and T_J = +25°C unless otherwise specified.

Parameter	Device	Conditions	Min	Typ	Max	Units
Thermal Regulation	AMS2501	T_A = 25°C, 30ms pulse, I_{LOAD} = 1A		0.002	0.020	%W
Dropout Voltage		Note 2				
Control Dropout ($V_{CONTROL}$ - V_{OUT})	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	V_{POWER} =V_{OUT} + 0.8V, I_{LOAD} = 10mA V_{POWER} =V_{OUT} + 0.8V, I_{LOAD} = 1A		**1.00** **1.15**	**1.15** **1.30**	V V
Power Dropout (V_{POWER} - V_{OUT})	AMS2501-1.5/-1.8/-2.5/-2.85/-3.0/-3.3/-3.5/-5.0	$V_{CONTROL}$ =V_{OUT} + 2.5V, I_{LOAD} = 1A		**.05** **.30**	**0.15** **0.50**	V V

Parameters identified with **boldface type** apply over the full operating temperature range.

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: Unless otherwise specified V_{OUT} = V_{SENSE}. For the adjustable device V_{ADJ} = 0V.

Note 3: The dropout voltage for the AMS2501 is caused by either minimum control voltage or minimum power voltage. The specifications represent the minimum input/output voltage required to maintain 1% regulation.

Note 4: For the adjustable device the minimum load current is the minimum current required to maintain regulation. Normally the current in the resistor divider used to set the output voltage is selected to meet the minimum load current requirement.

Note 5: The control pin current is the drive current required for the output transistor. This current will track output current with a ratio of about 1:100. The minimum value is equal to the quiescent current of the device.

PIN FUNCTIONS

V_{POWER} (Pin 1): This pin is the collector to the power device of the AMS2501. The output load current is supplied through this pin. The voltage at this pin must be between 0.1V and 0.8V greater than the output voltage for the device to regulate.

Output (Pin 2 and 3): These are the power output of the device. Pin 2 and 3 are fused together and with the package paddle serving also as heat sink.

Sense (Pin 4): This pin is the positive side of the reference voltage for the device. With this pin it is possible to Kelvin sense the output voltage at the load.

N/C (Pin 5): Not Connect.

Adjust (Pin 6): This pin is the negative side of the reference voltage for the device. Adding a small bypass capacitor from the Adjust pin to ground improves the transient response. For fixed voltage devices the Adjust pin is also brought out to allow the user to add a bypass capacitor.

N/C (Pin 7): Not Connect.

$V_{CONTROL}$ (Pin 8): This pin is the supply pin for the control circuitry of the device. The current flow into this pin will be about 1% of the output current. The voltage at this pin must be between 1.0V and 1.3V greater than the output voltage for the device to regulate.

APPLICATION HINTS

The AMS2501 series of adjustable and fixed regulators is designed to make use of multiple power supplies, existing in most systems, to reduce the dropout voltage. One of the advantages of the two supply approach is maximizing the efficiency.

The second supply is at least 1.2V greater than output voltage and is providing the power for the control circuitry and supplies the drive current to the NPN output transistor. This allows the NPN to be driven into saturation; thereby reducing the dropout voltage by a V_{BE} compared to conventional designs. For the control voltage the current requirement is small, equal to about 1% of the output current or approximately 10mA for a 1A load. Most of this current is drive current for the NPN output transistor. This drive current becomes part of the output current. The maximum voltage on the Control pin is 13V. The maximum voltage at the Power pin is 7V. Ground pin current for fixed voltage devices is typical 6mA and is constant as a function of load. Adjust pin current for adjustable devices is 40μA at 25°C and varies proportional to absolute temperature.

The improved frequency compensation of AMS2501 permits the use of capacitors with very low ESR. Output voltage tolerances are tighter and include transient response as part of the specification. Designed to meet the fast current load step, the AMS2501 also saves total cost by needing less output capacitance to maintain regulation.

Careful design of the AMS2501 has eliminated any supply sequencing issues associated with a dual supply system. The output voltage will not turn on until both supplies are operating. If the control voltage comes up first, the output current will be limited to a few milliamperes until the power input voltage comes up. If power input comes up first the output will not turn on at all until the control voltage comes up. The output can never come up unregulated. By tying the control and power inputs together the AMS2501 can also be operated as a single supply device. In single supply operation the dropout will be determined by the minimum control voltage.

Both the fixed and adjustable versions have remote sense pins, permitting very accurate regulation of output voltage at the load, rather than at the regulator. As a result, over an output current range of 100mA to 1A with a 2.5V output, the typical load regulation is less than 1mV. Optimum transient response is provided using a capacitor in the range of 0.1μF to 1μF for bypassing the Reference pin. The value chosen will depend on the amount of output capacitance in the system.

This devices can hold 1% accuracy over the full temperature range and load current range, guaranteed, when combined with ratiometrically accurate internal divider resistors and operating with an input/output differential of well under 1V.

Typical applications for the AMS2501 include 3.3V to 2.5V conversion with a 5V control supply, 5V to 4.2V conversion with a 12V control supply or 5V to 3.6V conversion with a 12V control supply. Capable of 1A of output current with a maximum dropout of 0.8V the AMS2501 also has a fast transient response that allows it to handle large current changes. The device is fully protected against overcurrent and overtemperature conditions.

Grounding and Output Sensing

The AMS2501 allows true Kelvin sensing for both the high and low side of the load. As a result the voltage regulation at he load can be easily optimized. Voltage drops due to parasitic resistances between the regulator and the load can be placed inside the regulation loop of the AMS2501. The advantages of remote sensing are illustrated in figures 1 through 3.

Figure 1 shows the device connected as a conventional 3 terminal regulator with the Sense lead connected directly to the output of the device. R_P is the parasitic resistance of the connections between the device and the load. R_P is made up of the PCB traces and /or connector resistances (in the case of a modular regulator) between the regulator and the load. Trace A of figure 3 illustrates the effect of R_P. Very small resistances cause significant load regulation steps.

Figure 2 shows the device connected to take advantage of the remote sense feature. The Sense pin and the top of the resistor divider are connected to the top of the load; the bottom of the resistor divider is connected to the bottom of the load. R_P is now connected inside the regulation loop of the AMS2501 and for reasonable values of R_P the load regulation at the load will be negligible. The effect on output regulation can be seen in trace B of figure 3.
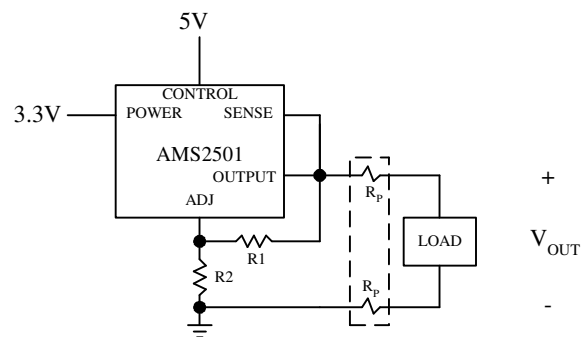

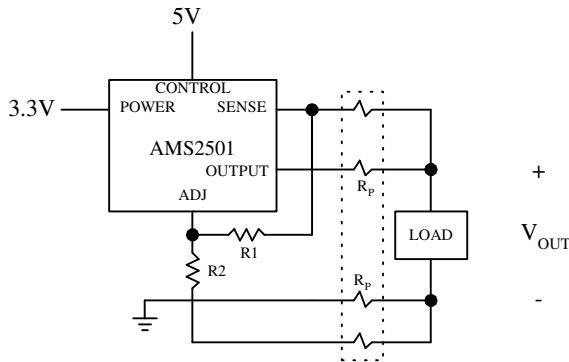**Figure 1. Conventional Load Sensing**

APPLICATION HINTS

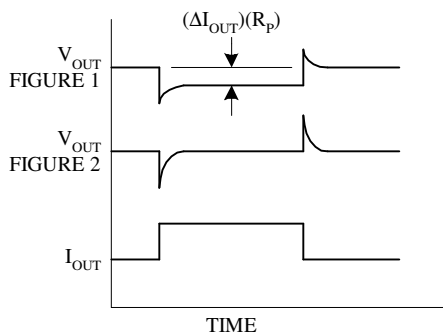

Figure 2. Remote Load Sensing

Figure 3. Remote Sensing Improves Load Regulation

Voltage drops due to R_P are not eliminated; they will add to the dropout voltage of the regulator regardless of whether they are inside or outside the regulation loop. The AMS2501 can control the voltage at the load as long as the input-output voltage is greater than the total of the dropout voltage of the device plus the voltage drop across R_P.

Stability

The circuit design used in the AMS2501 series requires the use of an output capacitor as part of the device frequency compensation. The addition of 150µF aluminum electrolytic or a 22µF solid tantalum on the output will ensure stability for all operating conditions. For best frequency response use capacitors with an ESR of less than 1Ω.

In order to increase the transient response larger value capacitors are needed. To limit the high frequency noise generated by the load high quality bypass capacitors must be used. In order to limit parasitic inductance (ESL) and resistance (ESR) in the capacitors to acceptable limits, multiple small ceramic capacitors in addition to high quality solid tantalum capacitors are required.

When the adjustment terminal is bypassed to improve the ripple rejection, the requirement for an output capacitor increases. The reference voltage is brought out specifically to allow this capability.

Some of the loads generate large high frequency current transients. The load current step contains higher order frequency components than the output coupling network must handle until the regulator throttles to the load current level. Because they contain parasitic resistance and inductance, capacitors are not ideal elements. These parasitic elements dominate the change in output voltage at the beginning of a transient load step change. The ESR of the output capacitors produces an instantaneous step in output voltage $(\Delta V=\Delta I)(ESR)$. The ESL of the output capacitors produces a droop proportional to the rate of change of the output current $(V=L)(\Delta I/\Delta t)$. The output capacitance produces a change in output voltage proportional to the time until the regulator can respond $(\Delta V=\Delta t)(\Delta I/C)$. Figure 4 illustrates these transient effects.
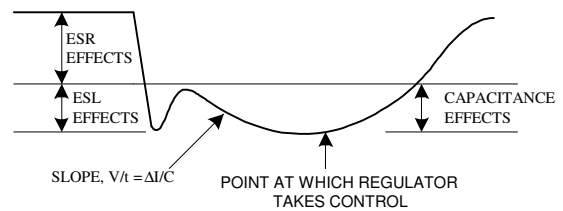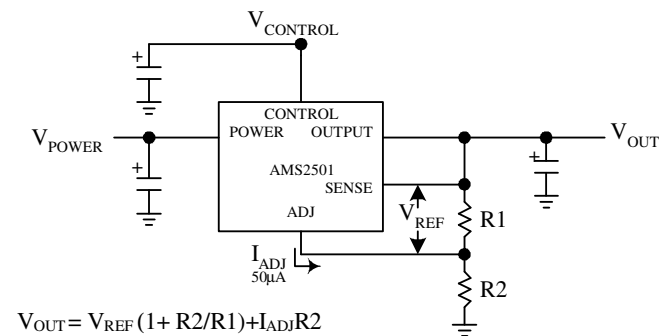

Figure 4.

Output Voltage

The AMS2501 series develops a 1.25V reference voltage between the Sense pin and the Adjust pin (Figure5). Placing a resistor between these two terminals causes a constant current to flow through R1 and down through R2 to set the overall output voltage. In general R1 is chosen so that this current is the specified minimum load current of 10mA.The current out of the Adjust pin is small, typically 40µA and it adds to the current from R1. Because I_{ADJ} is very small it needs to be considered only when very precise output voltage setting is required. For best regulation the top of the resistor divider should be connected directly to the Sense pin.

$$V_{OUT}= V_{REF}(1+ R2/R1)+I_{ADJ}R2$$

Figure 5. Setting Output Voltage

APPLICATION HINTS

Protection Diodes

Unlike older regulators, the AMS2501 family does not need any protection diodes between the adjustment pin and the output and from the output to the input to prevent die over-stress. Internal resistors are limiting the internal current paths on the AMS2501 adjustment pin, therefore even with bypass capacitors on the adjust pin no protection diode is needed to ensure device safety under short-circuit conditions. The Adjust pin can be driven on a transient basis ±7V with respect to the output without any device degradation.

Diodes between the Output pin and V_{POWER} pin are not usually needed. Microsecond surge currents of 10A to 25A can be handled by the internal diode between the Output pin and V_{POWER} pin of the device. In normal operations it is difficult to get those values of surge currents even with the use of large output capacitances. If high value output capacitors are used, such as 1000µF to 5000µF and the V_{POWER} pin is instantaneously shorted to ground, damage can occur. A diode from output to input is recommended, when a crowbar circuit at the input of the AMS2501 is used (Figure 6). Normal power supply cycling or even plugging and unplugging in the system will not generate current large enough to do any damage.
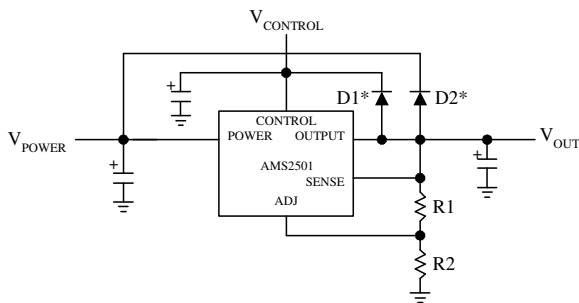

Figure 6. Optional Clamp Diodes Protect Against Input Crowbar Circuits

If the AMS2501 is connected as a single supply device with the control and power input pins shorted together the internal diode between the output and the power input pin will protect the control input pin. As with any IC regulator, none the protection circuitry will be functional and the internal transistors will break down if the maximum input to output voltage differential is exceeded.

Thermal Considerations

The AMS2501 series have internal power and thermal limiting circuitry designed to protect the device under overload conditions. However maximum junction temperature ratings should not be exceeded under continuous normal load conditions. Careful consideration must be given to all sources of thermal resistance from junction to ambient.

Control section can run up to 125°C, and the Power section can run up to 150°C. Due to the thermal gradients between the power transistor and the control circuitry there is a significant difference in thermal resistance between the Control and Power sections.

Virtually all the power dissipated by the device is dissipated in the power transistor. The temperature rise in the power transistor will be greater than the temperature rise in the Control section making the thermal resistance lower in the Control section. At power levels below 0.5W the temperature gradient will be less than 25°C and the maximum ambient temperature will be determined by the junction temperature of the Control section. This is due to the lower maximum junction temperature in the Control section. At power levels above 0.5W the temperature gradient will be greater than 25°C and the maximum ambient temperature will be determined by the Power section. In both cases the junction temperature is determined by the total power dissipated in the device. For most low dropout applications the power dissipation will be less than 0.5W.

The power in the device is made up of two components: the power in the output transistor and the power in the drive circuit. The power in the control circuit is negligible.

The power in the drive circuit is equal to:

$$P_{DRIVE} = (V_{CONTROL} - V_{OUT})(I_{CONTROL})$$

where $I_{CONTROL}$ is equal to between $I_{OUT}/100$(typ) and $I_{OUT}/60$(max).
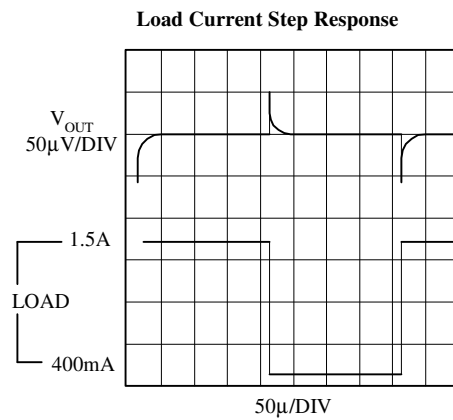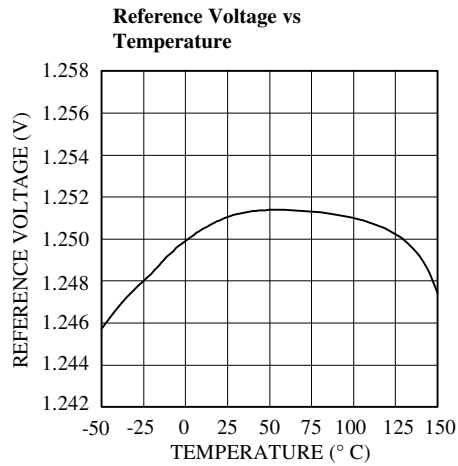
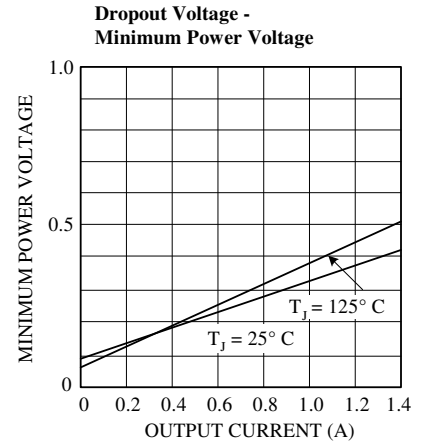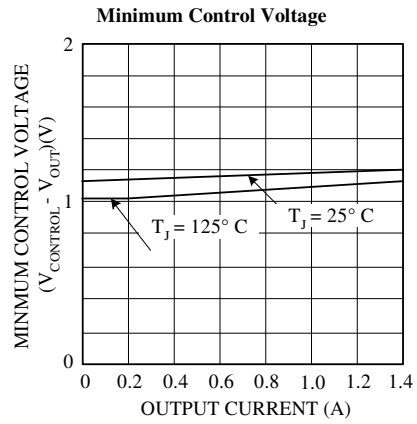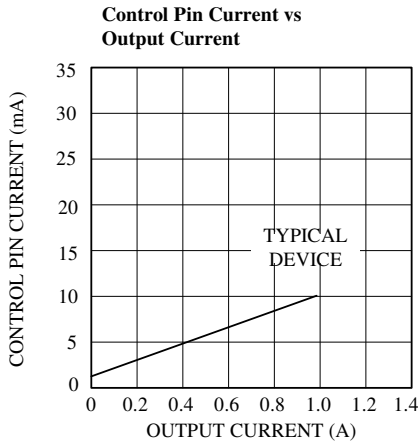The power in the output transistor is equal to:

$$P_{OUTPUT} = (V_{POWER} - V_{OUT})(I_{OUT})$$

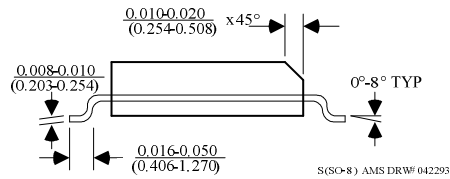The total power is equal to:
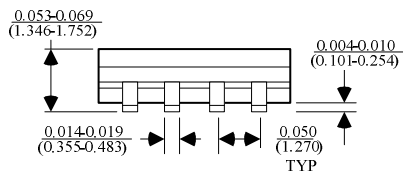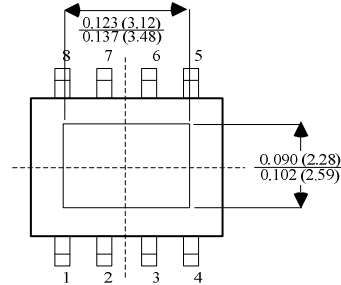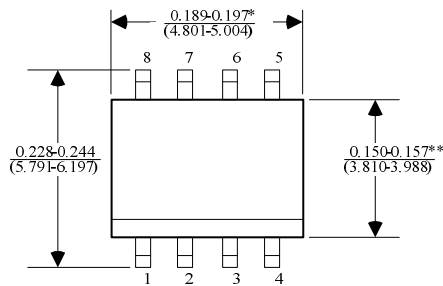
$$P_{TOTAL} = P_{DRIVE} + P_{OUTPUT}$$

Junction-to-case thermal resistance is specified from the IC junction to the bottom of the case directly below the die. This is the lowest resistance path for the heat flow. In order to ensure the best possible thermal flow from this area of the package to the PCB proper mounting is required.

TYPICAL PERFORMANCE CHARACTERISTICS

Control Pin Current vs Output Current

CONTROL PIN CURRENT (mA)

TYPICAL DEVICE

OUTPUT CURRENT (A)

Minimum Control Voltage

MINMUM CONTROL VOLTAGE ($V_{CONTROL}$ - V_{OUT})(V)

$T_J = 125°$ C

$T_J = 25°$ C

OUTPUT CURRENT (A)

Dropout Voltage - Minimum Power Voltage

MINIMUM POWER VOLTAGE

$T_J = 125°$ C

$T_J = 25°$ C

OUTPUT CURRENT (A)

Reference Voltage vs Temperature

REFERENCE VOLTAGE (V)

TEMPERATURE (° C)

Load Current Step Response

V_{OUT}
50μV/DIV

1.5A

LOAD

400mA

50μ/DIV

PACKAGE DIMENSIONS inches (millimeters) unless otherwise noted.

8 LEAD SOIC PLASTIC PACKAGE (S)

0.189-0.197*
(4.801-5.004)

8 7 6 5

0.228-0.244
(5.791-6.197)

0.150-0.157**
(3.810-3.988)

1 2 3 4

0.123 (3.12)
0.137 (3.48)

8 7 6 5

0.090 (2.28)
0.102 (2.59)

1 2 3 4

0.053-0.069
(1.346-1.752)

0.004-0.010
(0.101-0.254)

0.014-0.019
(0.355-0.483)

0.050
(1.270)
TYP

0.010-0.020
(0.254-0.508) x45°

0.008-0.010
(0.203-0.254)

0°-8° TYP

0.016-0.050
(0.406-1.270)

S(SO-8) AMS DRW# 042293

0.024(0.61)

0.050(1.27)

0.063(1.60)

0.105(2.67)

0.213(5.41)

0.138 (3.50)
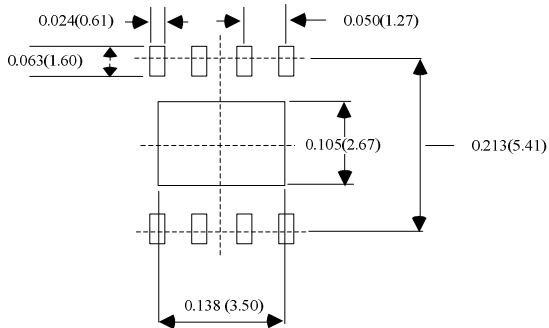
RECOMMENDED LAYOUT PATTERN

*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH
SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD
FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE